

CMOS Digital Integrated Circuits Silicon Monolithic

74HC573D

1. Functional Description

- Octal D-Type Latch with 3-State Outputs

2. General

The 74HC573D is a high speed CMOS OCTAL LATCH with 3-STATE OUTPUT fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

These 8-bit D-type latch is controlled by a latch enable input (LE) and an output enable input (OE).

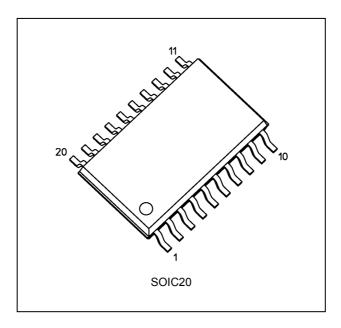
When the \overline{OE} input is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

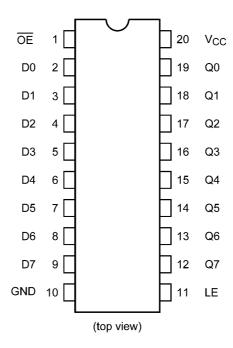
- (1) High speed: $t_{pd} = 13$ ns (typ.) at $V_{CC} = 6.0$ V
- (2) Low power dissipation: $I_{CC} = 4.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (3) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 6.0 V

4. Packaging

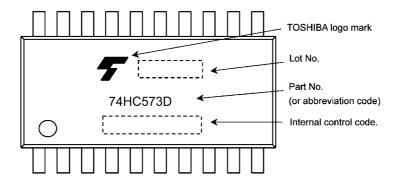




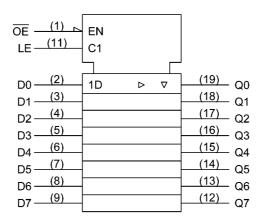
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



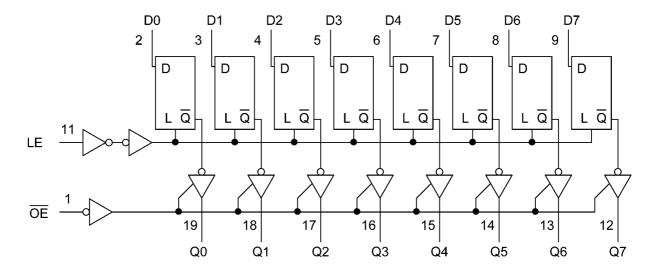
8. Truth Table

INPUT OE	INPUT LE	INPUT D	OUTPUT Q
Н	Х	Х	Z
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

X: Don't CareZ: High Impedance

Qn: Q outputs are latched at the time when the LE input is taken to low logic level.

9. System Diagram





10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	I _{OK}		±20	mA
Output current	I _{OUT}		±35	mA
V _{CC} /ground current	I _{CC}		±75	mA
Power dissipation	P _D	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: PD derates linearly with -8 mW/°C above 85°C

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 6.0	V
Input voltage	V _{IN}		0 to V _{CC}	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 85	ů
Input rise and fall times	t _r ,t _f	V _{CC} = 2.0 V	0 to 1000	ns
		V _{CC} = 4.5 V	0 to 500	
		V _{CC} = 6.0 V	0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	V
				6.0	4.20	_	_	V
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				4.5			1.35	V
				6.0		_	1.80	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5		
				6.0	5.9	6.0	_	
			I_{OH} = -6 mA	4.5	4.18	4.31	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.0	0.1	V
				4.5		0.0	0.1	
				6.0	_	0.0	0.1	
			I _{OL} = 6 mA	4.5	_	0.17	0.26	
			I _{OL} = 7.8 mA	6.0		0.18	0.26	V
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0		ı	±0.5	μА
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0		_	±0.1	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND $I_O = 0$ A		6.0	_	_	4.0	μА

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit	
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	V
Low-level input voltage	V _{IL}	_		2.0		0.50	V
				4.5		1.35	
				6.0		1.80	V
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -20 μA	2.0	1.9	_	\ \
				4.5	4.4	_	
				6.0	5.9	_	
			I _{OH} = -6 mA	4.5	4.13	_]
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.63	_	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 20 μA	2.0		0.1	V
				4.5	_	0.1	
				6.0	_	0.1	
			I _{OL} = 6 mA	4.5	_	0.33	
			I _{OL} = 7.8 mA	6.0	_	0.33	V
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	±5.0	μА
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0		±1.0	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND $I_O = 0$ A		6.0	_	40.0	μА



12.3. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	t _{w(H)}	_	2.0	75	ns
(LE)			4.5	15	
			6.0	13	
Minimum setup time	t _S	_	2.0	50	ns
			4.5	10	
			6.0	9	
Minimum hold time	t _h	_	2.0	5	ns
			4.5	5	
			6.0	5	

12.4. Timing Requirements (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	t _{w(H)}	_	2.0	95	ns
(LE)			4.5	19	
			6.0	16	
Minimum setup time	t _S	_	2.0	65	ns
			4.5	13	
			6.0	11	
Minimum hold time	t _h	_	2.0	5	ns
			4.5	5	
			6.0	5	



12.5. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		_	2.0	50	_	20	60	ns
				4.5		_	6	12	
				6.0			5	10	
Propagation delay time	t _{PLH} ,t _{PHL}		_	2.0	50	_	50	115	ns
(LE-Q)				4.5		_	15	23	
				6.0		_	13	20	
				2.0	150	_	60	155	ns
				4.5		_	20	31	
				6.0		_	17	26	
Propagation delay time	t _{PLH} ,t _{PHL}		_	2.0	50	_	42	110	ns
(D-Q)				4.5		_	14	22	
				6.0		_	12	19	
				2.0	150	_	57	150	ns
				4.5		_	19	30	
				6.0		_	16	26	
Output enable time	t _{PZL} ,t _{PZH}		$R_L = 1 k\Omega$	2.0	50	_	55	140	ns
				4.5		_	17	28	
				6.0		_	14	24	
				2.0	150	_	66	180	ns
				4.5		_	22	36	
				6.0		_	19	31	
Output disable time	t_{PLZ}, t_{PHZ}		$R_L = 1 k\Omega$	2.0	50	_	40	125	ns
				4.5		_	17	25	
				6.0		_	15	21	
Input capacitance	C _{IN}					_	5	10	pF
Output capacitance	C _{OUT}					_	10	_	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_			_	51	_	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per latch)

And the total C_{PD} when n pcs. of latch operate can be gained by the following equation:

 C_{PD} (total) = 33 + 18 × n



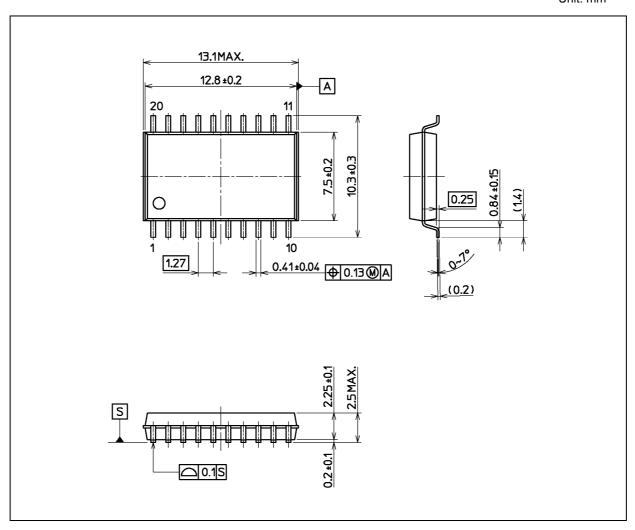
12.6. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_f = t_f = 6 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}		_	2.0	50	_	75	ns
				4.5		_	15	
				6.0		_	13	
Propagation delay time	t _{PLH} ,t _{PHL}		_	2.0	50	_	145	ns
(LE-Q)				4.5		_	29	
				6.0		_	25	
				2.0	150	_	195	ns
				4.5		_	39	
				6.0		_	33	
Propagation delay time	t _{PLH} ,t _{PHL}		_	2.0	50	_	140	ns
(D-Q)				4.5		_	28	
				6.0		_	24	
				2.0	150	_	190	ns
				4.5		_	38	
				6.0		_	32	
Output enable time	t _{PZL} ,t _{PZH}		$R_L = 1 k\Omega$	2.0	50	_	175	ns
				4.5		_	35	
				6.0		_	30	
				2.0	150	_	225	ns
				4.5		_	45	
				6.0		_	38	
Output disable time	t _{PLZ} ,t _{PHZ}		$R_L = 1 k\Omega$	2.0	50	_	155	ns
				4.5		_	31	1
				6.0		_	26	1 I
Input capacitance	C _{IN}		_	•		_	10	pF



Package Dimensions

Unit: mm



Weight: 0.51 g (typ.)

	Package Name(s)	
Nickname: SOIC20		



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